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6AV3971-1BA03-0CA0

MEMORY SUBMODULE FOR TD10 WITH FIRMWARE FOR AS511, FAP, L1, PARALLEL, 256 KBYTES

Notes

No picture available

Product was deleted without replacement
If you need assistance please contact our local Siemens office

List Price	Show prices
Customer Price	Show prices
DataSheet in PDF	Download
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Product

Article Number (Market Facing Number)	6AV3971-1BA03-0CA0
Product Description	MEMORY SUBMODULE FOR TD10 WITH FIRMWARE FOR AS511, FAP, L1, PARALLEL, 256 KBYTES
Product family	Not available
Product Lifecycle (PLM)	PM500:Discontinued Product or end of PLM & Support
PLM Effective Date	End of product lifecycle since: 01.10.2010
Notes	Product was deleted without replacement If you need assistance please contact our local Siemens office

Price data

Region Specific PriceGroup / Headquarter Price Group	2AP / 2AP
List Price	Show prices
Customer Price	Show prices
Surcharge for Raw Materials	None
Metal Factor	None

Delivery information

Export Control Regulations	ECCN : EAR99H / AL : N
Estimated dispatch time (Working Days)	1 Day/Days
Net Weight (kg)	0,078 Kg
Packaging Dimension	9,50 x 15,00 x 3,00
Package size unit of measure	CM
Quantity Unit	0 Piece
Packaging Quantity	1

Additional Product Information

EAN	Not available
UPC	Not available
Commodity Code	84717098
LKZ_FDB/ CatalogID	ST80E
Product Group	2343
Group Code	R119
Country of origin	Germany
Compliance with the substance restrictions according to RoHS directive	Product is not RoHS-compliant
Product class	D: products made to order / customer's specifications, requiring engineering services, which cannot be re-used or utilized (design to customer)
WEEE (2012/19/EU) Take-Back Obligation	-
REACH Art. 33 Duty to inform according to the current list of candidates	
SCIP number	Not available

Classifications

Not available

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